Electronic Acknowledgement Receipt					
EFS ID:	10351645				
Application Number:	10577173				
International Application Number:					
Confirmation Number:	1239				
Title of Invention:	SEMICONDUCTOR DEVICE WITH PLASTIC PACKAGE MOLDING COMPOUN SEMICONDUCTOR CHIP AND LEADFRAME AND METHOD FOR PRODUCING THE SAME				
First Named Inventor/Applicant Name:	Wolfgang Hetzel				
Customer Number:	73158				
Filer:	Mark L. Gleason/Connie Scheff				
Filer Authorized By:	Mark L. Gleason				
Attorney Docket Number:	1441.141.101				
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Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1 Jesus Foe Payment (PTO 95P)	issuefeepayment.pdf	152201	no	1	
	1 Issue Fee Payment (PTO-85B)	issuereepayment.pur	2beda095ea84ff2738513fdf2eb064dc39af7 b30	no	'
Warnings:					
Information:					
2 Miscellaneous Incoming Letter	Changeof Entity Status_to_small .pdf	47287	no	1	
		03b273b99d97794ad75bf0c0c0e31662cb1 05c88			
Warnings:		•	'		
Information:			4		
3	Fee Worksheet (SB06)	fee-info.pdf	31989	no	2

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New Applications Under 35 U.S.C. 111

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National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.